

A

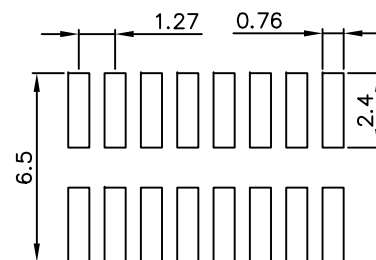
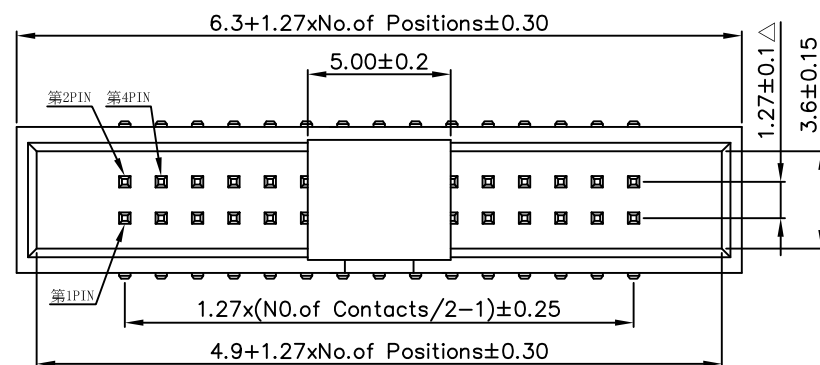
B

C

D

E

1

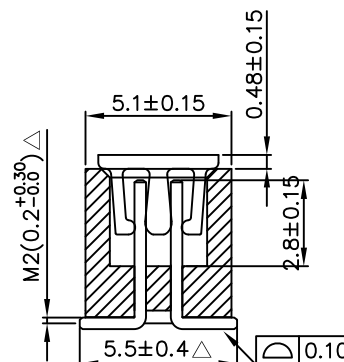
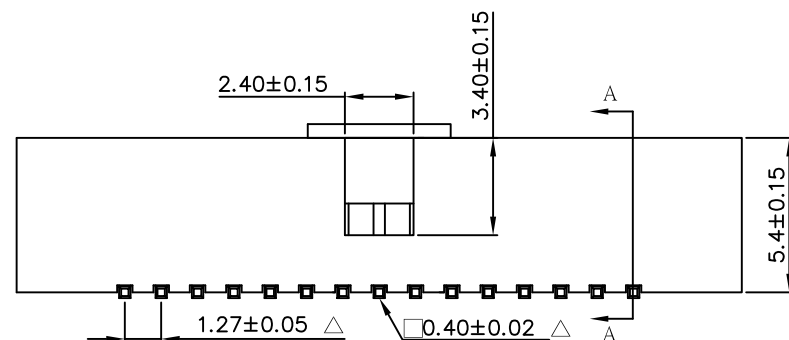


P. C. Board Layout

Specifications

Current Rating	:1 Amp
Insulator Resistance	:1000 Megohms Min.
Dielectric Withstanding	:AC 500 V
Operating Temperature	: $-40^{\circ}\text{C} \sim +105^{\circ}\text{C}$
Max Processing	: 260°C for 3~5sec. Max
Contact Material	:Copper Alloy
Insulator Material	:NY-6T/LCP, UL94V-0
Standard	:NY-6T Black
Finish	:Gold Plated
Standard	:Gold Flash all over

2



SEC:A-A

Series

B613

(Box Header)
B613 (1.27
H:5.4 W:5.1)

Connector
Type

X

M:SMT Type
M2:0.2mm
...

Contact
Plating

X

G:Gold Flash
T:Tin Plated
A:10U"Gold
B:15U"Gold
C:20U"Gold
©Duplex Plating
D:Gold Flash/Tin
Y:Gold Flash/Tin 30U"
(Standard:G)

Material

X

N:NY-6T
C:LCP
(Standard:N)

Pin Length mm

DXXX

M-D D-055

Number of
Contacts

XX

(10 TO 100
Contacts)

Other

RC

R:Reel
C:CAP

3

东莞华连电子有限公司

DESCRIPTION(内容):

1.27mm Box Header H:5.4 W:5.1 SMT
Reel+CAP (RoHS)

PART NO:
(料 號)

B613-M2G_-D055-XX-RC

DWG NO(圖號):

DRAWN(製圖):

Bingqiu Huang

CHECKED(確認):

Bingqiu Huang

APPROVAL(核准):

Bingqiu Huang

GENERAL TOLERANCE:

(公差)

.X

.XX

.XXX

.XXXX

.X°

.XX°

SCALE(比例):

1:XX



REV:

A/3

UNIT:

mm

SIZE:

A4

SHEET:

1/1

REV

1

2

3

4

DESCRIPTION

△此符號表示重點管控尺寸

修改尺寸公差

修正內腔寬尺寸

DATE

2017.09.20

2018.01.04

2020.08.09

A

B

C

D

E